



BTA10 GP

TRIACS

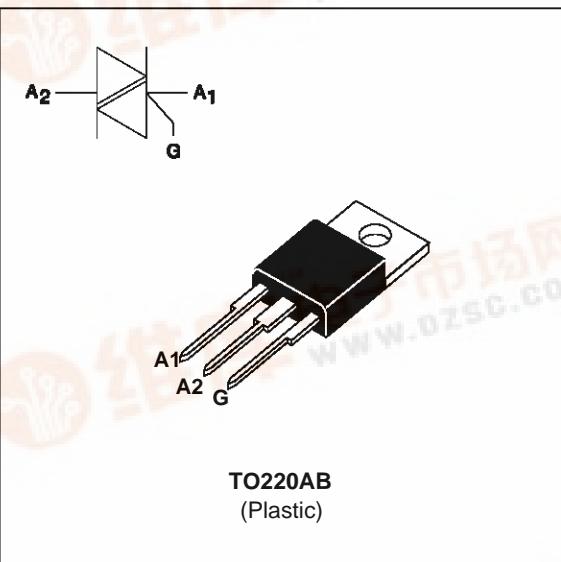
FEATURES

- LOW I_H = 13mA max
- HIGH SURGE CURRENT : $I_{TSM} = 120A$
- I_{GT} SPECIFIED IN FOUR QUADRANTS
- INSULATING VOLTAGE = 2500V(RMS)
(UL RECOGNIZED : E81734)

DESCRIPTION

The BTA10 GP's use high performance, glass passivated chips.

The insulated TO220AB package, the high surge current and low holding current make this family well adapted to LIGHT DIMMER applications.



ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit
I_T (RMS)	RMS on-state current (360° conduction angle)	10	A
I_{TSM}	Non repetitive surge peak on-state current (T_j initial = 25°C)	$t_p = 8.3$ ms	A
		$t_p = 10$ ms	
I^2t	I^2t value	72	A^2s
dl/dt	Critical rate of rise of on-state current Gate supply : $I_G = 500mA$ $diG/dt = 1A/\mu s$	Repetitive $F = 50$ Hz	$A/\mu s$
		Non Repetitive	
T_{stg} T_j	Storage and operating junction temperature range	- 40 to + 150	$^{\circ}C$
		- 40 to + 125	$^{\circ}C$
T_l	Maximum lead temperature for soldering during 10 s at 4.5 mm from case	260	$^{\circ}C$

Symbol	Parameter	BTA10-		Unit
		400 GP	600 GP	
V_{DRM} V_{RRM}	Repetitive peak off-state voltage $T_j = 125$ °C	400	600	V

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THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
R _{th} (j-a)	Junction to ambient	60	°C/W
R _{th} (j-c) DC	Junction to case for DC	4	°C/W
R _{th} (j-c) AC	Junction to case for 360° conduction angle (F= 50 Hz)	3	°C/W

GATE CHARACTERISTICS (maximum values)

P_G (AV) = 1W P_{GM} = 10W (tp = 20 μs) I_{GM} = 4A (tp = 20 μs) V_{GM} = 16V (tp = 20 μs).

ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions	Quadrant		Suffix	Unit
				GP	
I _{GT}	V _D =12V (DC) R _L =33Ω	T _j =25°C	I-II-III	MAX	50
			IV	MAX	75
V _{GT}	V _D =12V (DC) R _L =33Ω	T _j =25°C	I-II-III-IV	MAX	1.5
V _{GD}	V _D =V _{DRM} R _L =3.3kΩ	T _j =110°C	I-II-III-IV	MIN	0.2
t _{gt}	V _D =V _{DRM} I _G = 500mA dI _G /dt = 3A/μs	T _j =25°C	I-II-III-IV	TYP	2
I _L	I _G =1.2 I _{GT}	T _j =25°C	I-III-IV	TYP	20
			II		40
I _H *	I _T = 100mA gate open	T _j =25°C		MAX	13
V _{TM} *	I _{TM} = 14A tp= 380μs	T _j =25°C		MAX	1.5
I _{DRM} I _{RRM}	V _{DRM} Rated V _{RRM} Rated	T _j =25°C		MAX	0.01
		T _j =110°C		MAX	0.5
dV/dt *	Linear slope up to V _D =67%V _{DRM} gate open	T _j =110°C		MIN	30
				TYP	100
(dV/dt)c *	(dI/dt)c= 2.2A/ms	T _j =110°C		MIN	1
				TYP	10

* For either polarity of electrode A₂ voltage with reference to electrode A₁.

Fig.1 : Maximum RMS power dissipation versus RMS on-state current ($F=50\text{Hz}$).
 (curves are cut off by $(dI/dt)c$ limitation)

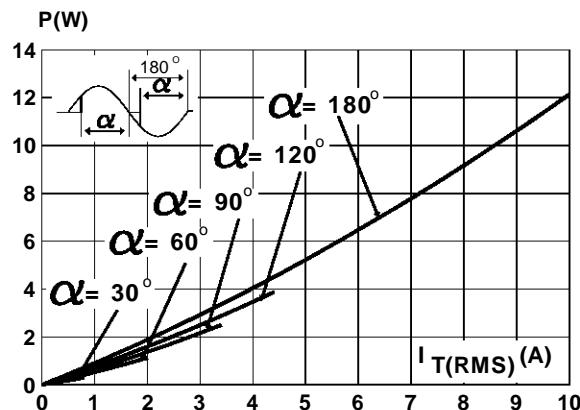


Fig.3 : RMS on-state current versus case temperature.

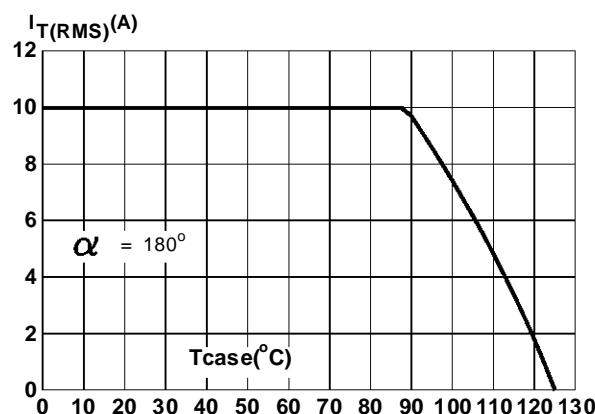


Fig.5 : Relative variation of gate trigger current and holding current versus junction temperature.

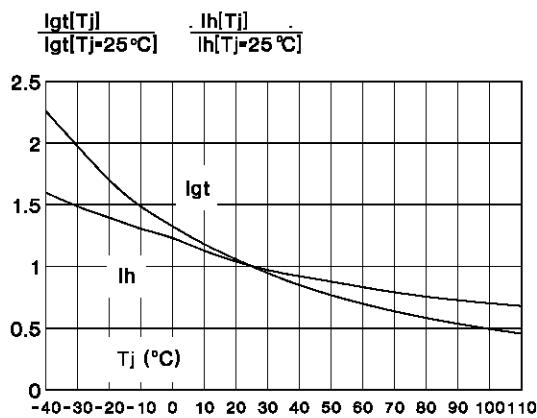


Fig.2 : Correlation between maximum RMS power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatsink + contact.

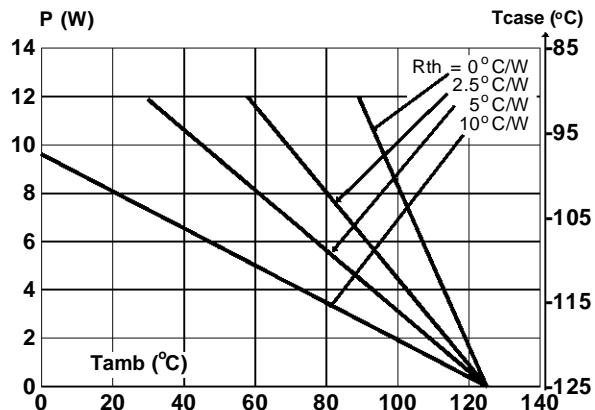


Fig.4 : Relative variation of thermal impedance versus pulse duration.

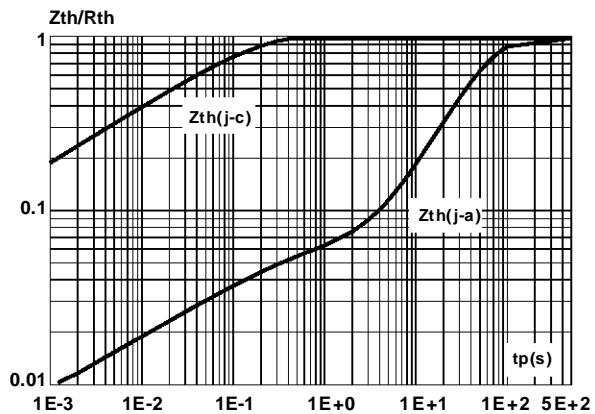
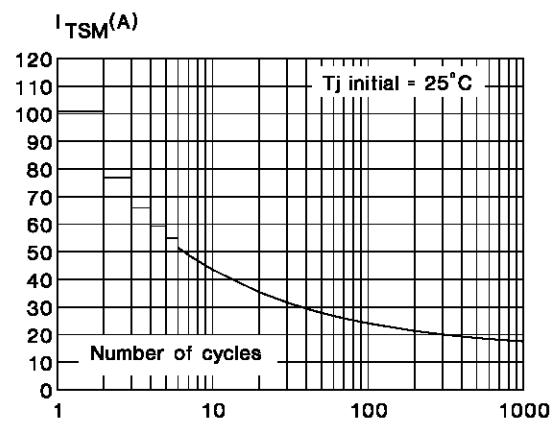


Fig.6 : Non repetitive surge peak on-state current versus number of cycles.



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Fig.7 : Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \leq 10\text{ms}$, and corresponding values of I^2t .

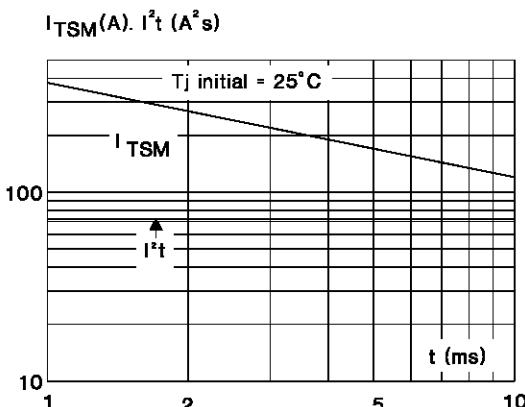
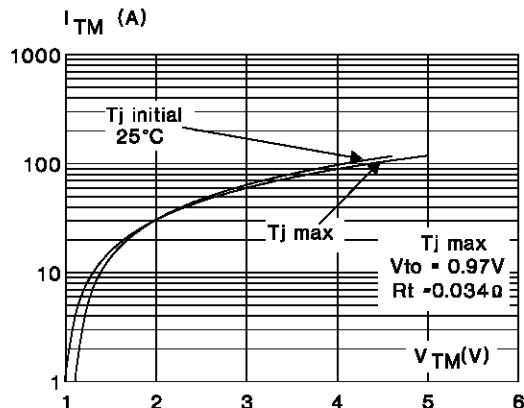
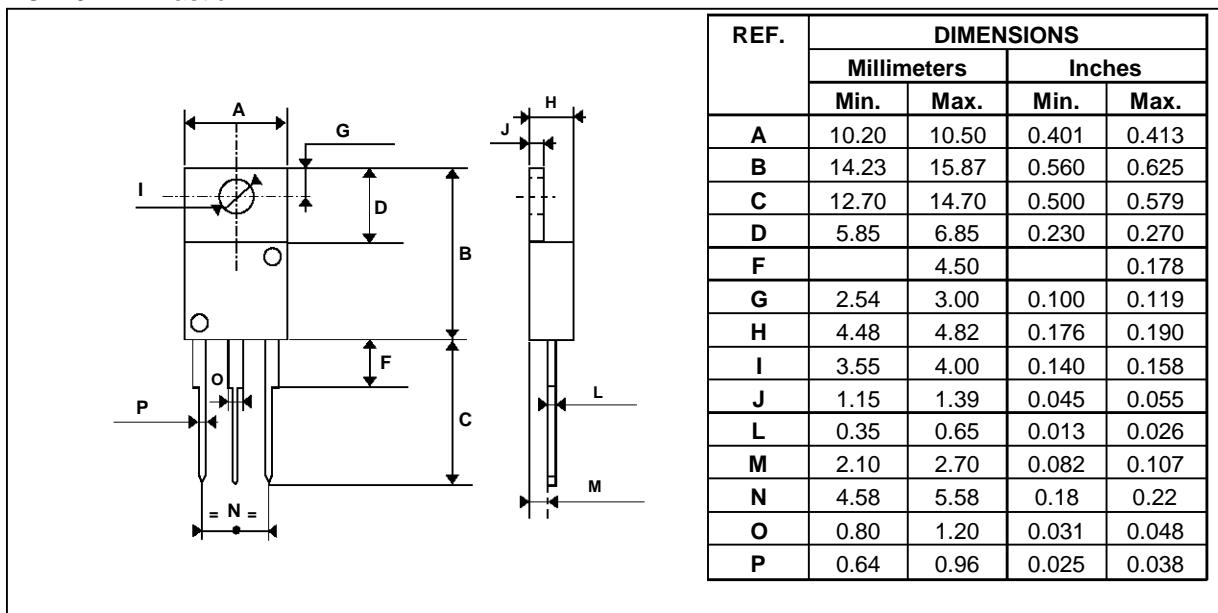


Fig.8 : On-state characteristics (maximum values).



PACKAGE MECHANICAL DATA

TO220AB Plastic



Cooling method : C

Marking : type number

Weight : 2.3 g

Recommended torque value : 0.8 m.N.

Maximum torque value : 1 m.N.

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